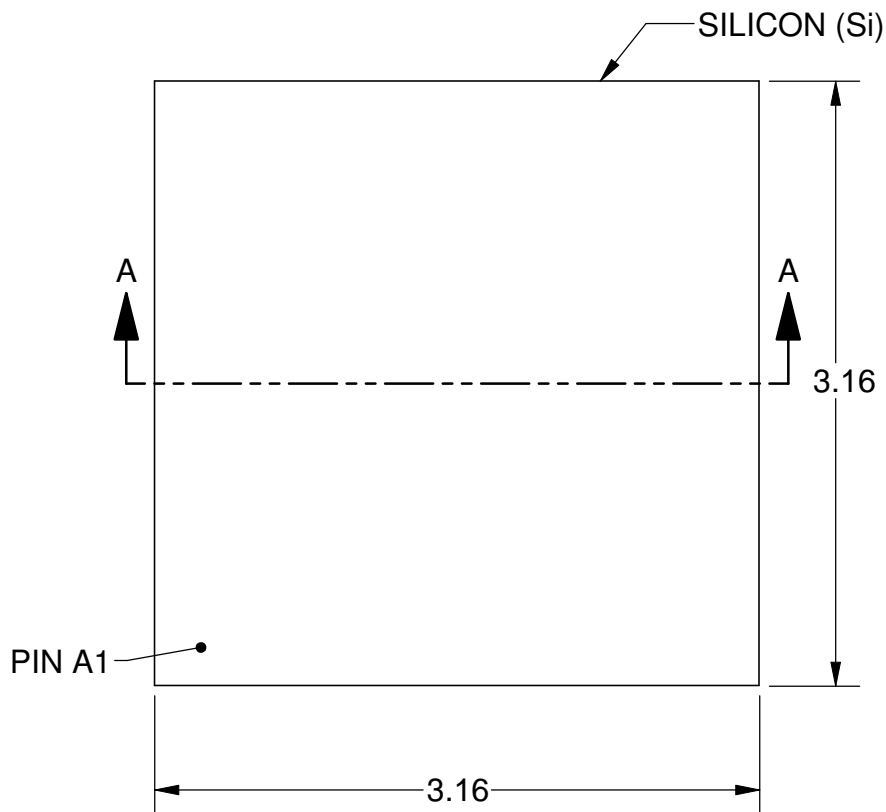
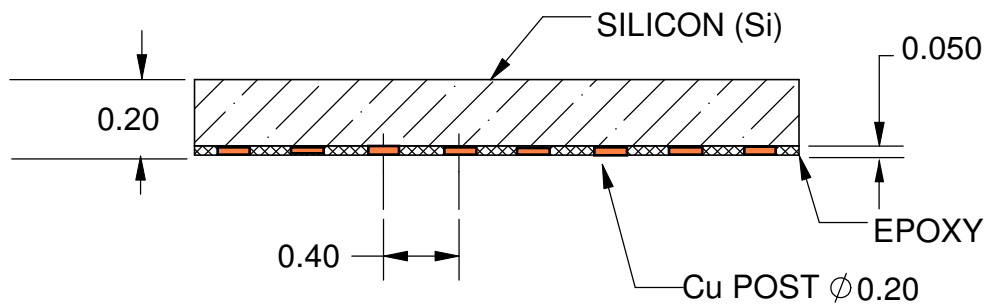
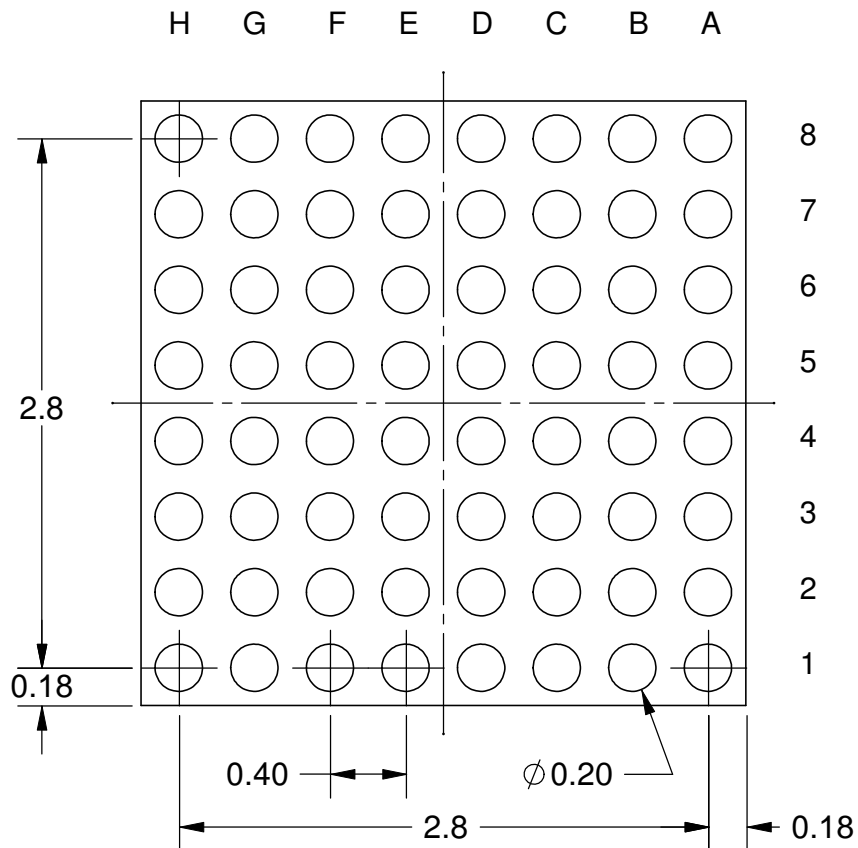


TOP VIEW




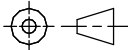
PAD VIEW



SECTION A-A

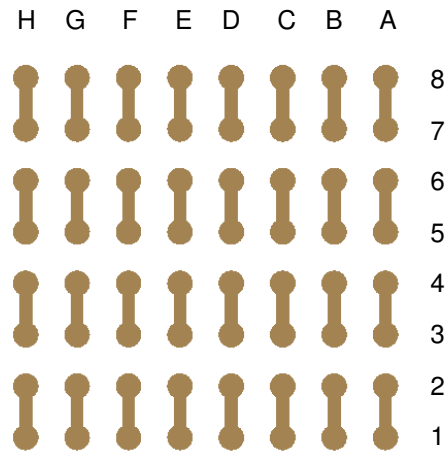
Notes: (Unless Otherwise Specified).

- 1) ALL DIMENSIONS ARE IN MM.
- 2) PAD ALLOY: Cu Post (50um Thick)
- 3) PAD Cu DIAMETER: 0.20mm.
- 4) DIE MATERIAL: Si (SILICON).
- 5) DAISY CHAIN PATTERN (SEE PAGE 2).

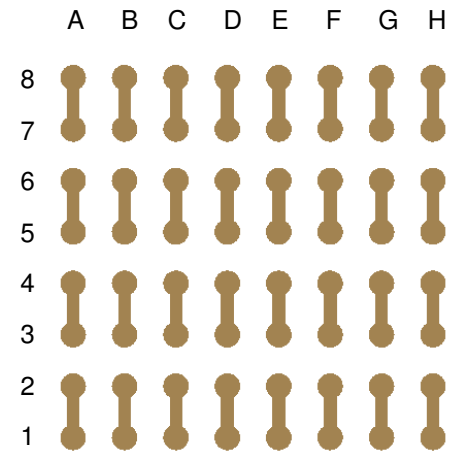
TOLERANCE UNLESS NOTED		APPROVALS		DATE								
X.X	+/- 0.3	DRAWN J. Hines		12/30/2010						TITLE		
X.XX	+/- 0.03	ENG				eWLP64T.4-DC088D						
X.XXX	+/- 0.003	MFG				64-L P=0.4mm (TEG0408)						
ANGLES +/- 0.5°		QA				SCALE		SIZE		DRAWING NO.		REV
ALL DIMENSIONS IN		CUST				25:1		A		640880		A
<input type="checkbox"/> INCHES <input checked="" type="checkbox"/> MILLIMETERS		THIRD ANGLE PROJECTION		REVISED						DO NOT SCALE DRAWING		SHEET 1 OF 2
												

DAISY CHAIN PATTERN

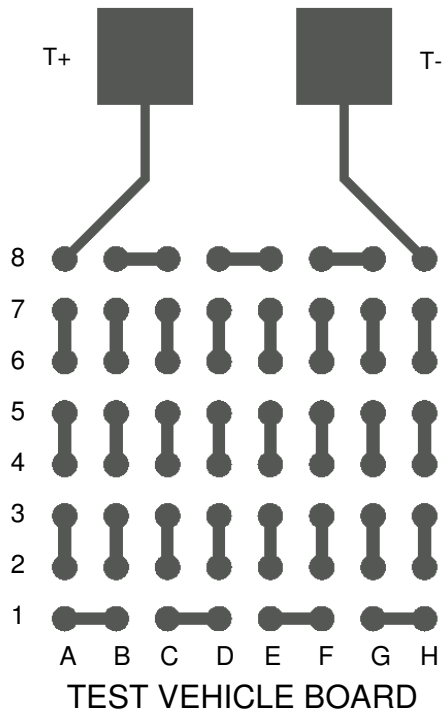
PAD VIEW



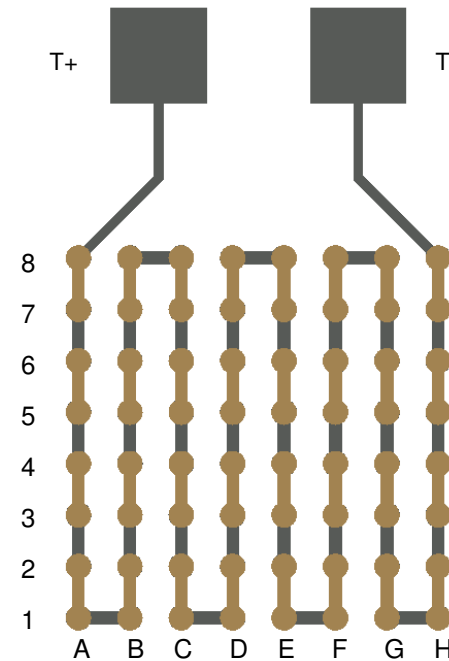
BOTTOM SIDE
(TOP X-RAY VIEW)



TOP VIEW



AFTER MOUNTING
TO TEST BOARD
(TOP X-RAY VIEW)



Notes:

- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.

TopLine ®			
TITLE eWLP64T.4-DC088D 64-L P=0.4mm (TEG0408)			
SCALE 17:1	SIZE	DRAWING NO. 640880	REV A
DO NOT SCALE DRAWING		SHEET 2 OF 2	